



JMPL1050PU

Features

- Excellent $R_{DS(ON)}$ and Low Gate Charge
- 100% UIS Tested
- 100% V_{DS} Tested
- Halogen-free; RoHS-compliant
- Pb-free plating

Applications

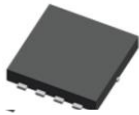
- Load Switch
- PWM Application
- Power Management

Product Summary

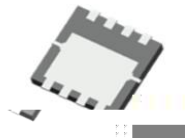
Parameters	Value	Unit
V_{DSS}	-100	V
$V_{GS(th)}_{Typ}$	-1.7	V
$I_D(@V_{GS}=-10V)$	-17	A
$R_{DS(ON)}_{Typ}(@V_{GS}=-10V)$	39	$m\Omega$
$R_{DS(ON)}_{Typ}(@V_{GS}=-4.5V)$	51	$m\Omega$



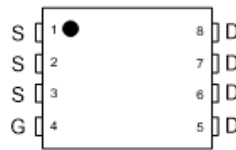
Top View



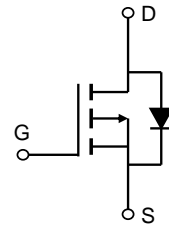
Bottom View



PDFN3x3-8L



Pin Assignment



Schematic Diagram

Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)
JMPL1050PU-13	PL1050P	1	Tape&Reel	PDFN3x3-8L	5000	50000

Absolute Maximum Ratings (@ $T_C = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-to-Source Voltage	-100	V
V_{GS}	Gate-to-Source Voltage	± 20	V
I_D	Continuous Drain Current	$T_C = 25^\circ\text{C}$	-17
		$T_C = 100^\circ\text{C}$	-11
I_{DM}	Pulsed Drain Current ⁽¹⁾	Refer to Fig.4	A
E_{AS}	Single Pulsed Avalanche Energy ⁽²⁾	165	mJ
P_D	Power Dissipation	$T_C = 25^\circ\text{C}$	30
		$T_C = 100^\circ\text{C}$	12
T_J, T_{STG}	Junction & Storage Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Max	Unit
R	Thermal Resistance, Junction to Ambient ⁽³⁾	48	$^\circ\text{C}/\text{W}$
R	Thermal Resistance, Junction to Case	4.2	

Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics					
V _{(BR)DSS}		-100	-	-	V
I _{DSS}		-	-	-1.0	μA
I _{GSS}		-	-	±100	nA
On Characteristics					
V _{GS(th)}		-1.2	-1.7	-2.2	V
		-	39	51	mΩ
		-	51	67	mΩ
R _g		-	7.5	-	Ω
C _{iss}		1261	1765	2383	pF
C _{oss}		147	205	277	pF
C _{riss}		12	17	24	pF
Q _g		19	27	36	nC
Q _{gs}		-	7.4	-	nC
Q _{gd}		-	4.1	-	nC
Switching Characteristics					
t _{d(on)}		-	7	-	ns
t _r		-	6.5	-	ns
t _{d(off)}		-	38	-	ns
t _f		-	9.4	-	ns
Static Characteristics					
I _S		-	-	-17	A
I _{SM}		-	-	-69	A
V _{SD}		-	-	-1.2	V
t _{rr}		35	49	67	ns
Q _{rr}		-	128	-	nC

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
 2. E_{AS} condition: Starting T_J=25°C, V_{DD}=-50V, V_{GS}=-10V, R_G=25ohm, L=3mH, I_{AS}=-10.5A, V_{DD}=0V during time in avalanche.
 3. R_g is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.
 4. Pulse Test: Pulse Width

Typical Performance Characteristics

Figure 5: Output Characteristics

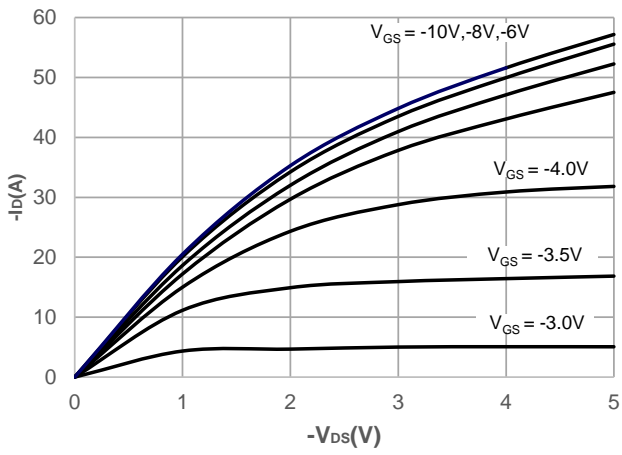


Figure 6: Typical Transfer Characteristics

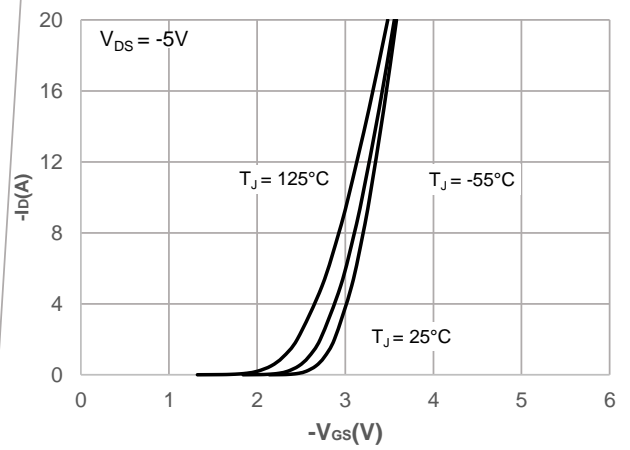


Figure 7: On-resistance vs. Drain Current

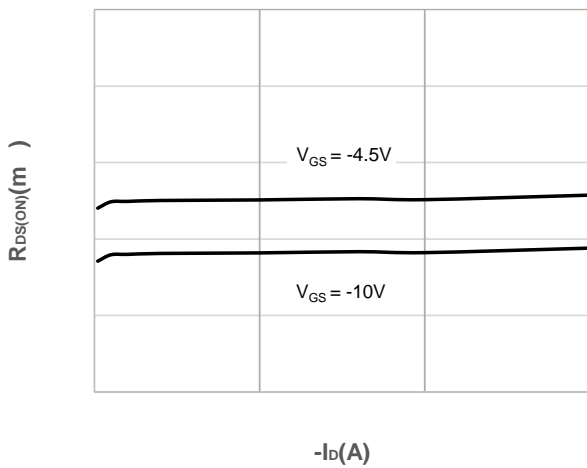
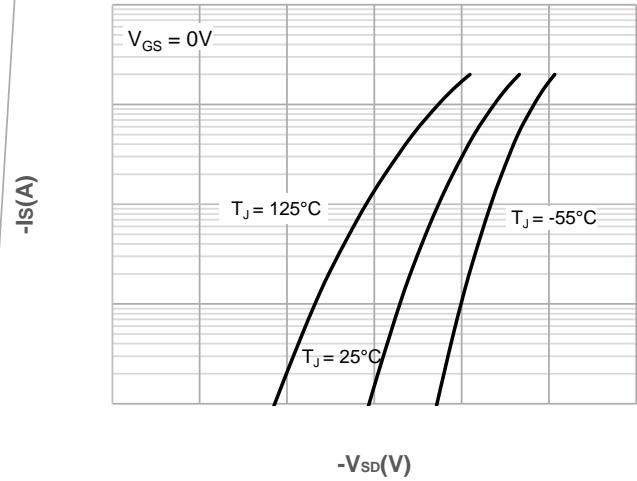


Figure 8: Body Diode Characteristics





Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

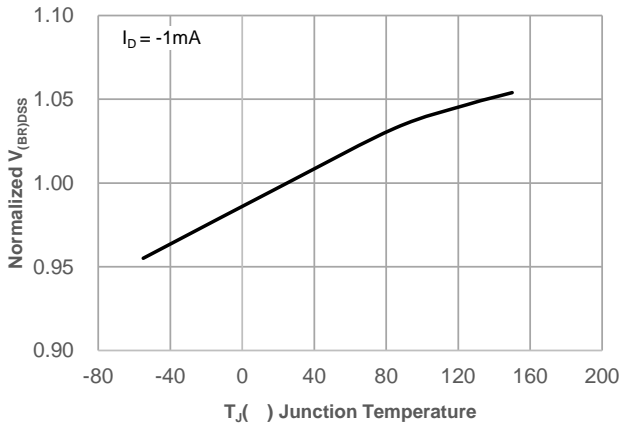


Figure 12: Normalized on Resistance vs. Junction Temperature

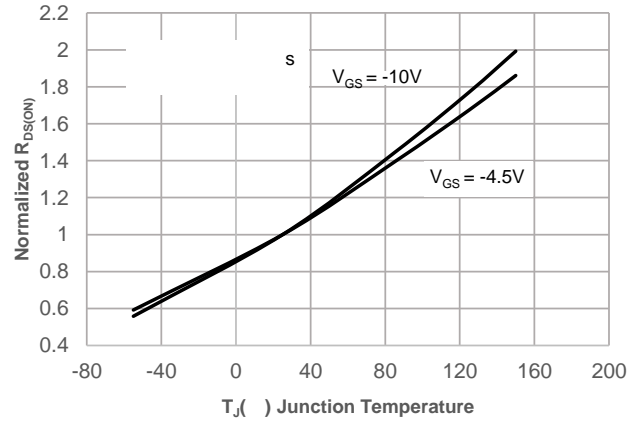


Figure 14: $R_{DS(ON)}$ vs. V_{GS}

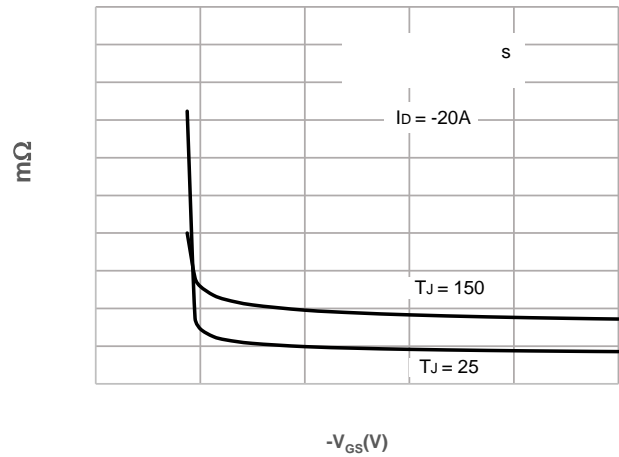
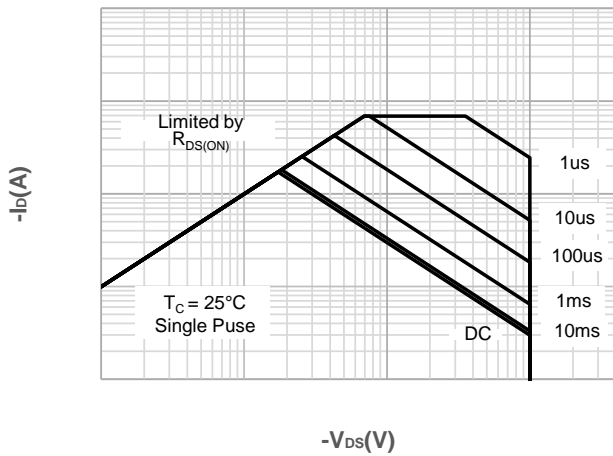


Figure 15: Maximum Safe Operating Area



Test Circuit

Package Mechanical Data(PDFN3X3-8L)